IPC ASSOCIATION ELECTRONICS	Material Com © Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				erials and l	rials and Mfg Information			
upplier	r Information														
Company name*				Company unique ID			Unique ID Authority				Respo	Response Date*			
nsemi											2024-0	2024-04-25			
ontact Na	ame		Title - Contact			P	Phone - Contact*				Email	Email - Contact*			
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roduct-E	Env-Stewards	Product Enviro Compliance			I	NA				Produ	Product-Env-Stewards@onsemi.com				
	Requester Item Number		Mfr Item Number Mfr Item Nam		ne		Effective Date	Version	M	Manufacturing Site		Weight*	UOM	Unit Type	
		KSC2328AYTA NPN/30V/2A/10		NPN/30V/2A/160	-320	2024-04-25 CNF		NF		344.702	mg	Each			
	cturing Process Informa		Cerminal Base	Alloy	-STD-020 MS	U. Dating	Dook Dwoo	nes Pody 7	Comporatur	e Max Time at Pe	ak Tampar	atura Numb	er of Reflow Cyc	alac	
	3		CU Allov NA			ol Kanng	0	ess body 1	C	30	Τ'	onds 3	er of Kellow Cyc	ries	
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RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.169	mg	Supplier	Silicon (Si)	7440-21-3		0.169	mg
Lead Frame	173.0		Supplier	Silver (Ag)	7440-22-4		0.689	mg
			Supplier	Iron (Fe)	7439-89-6		0.173	mg
			Supplier	Copper (Cu)	7440-50-8		172.086	mg
			Supplier	Phosphorus (P)	7723-14-0		0.052	mg
Mold Compound-Black	159.0	mg		Phenol Resin	proprietary data		15.9	mg
			Supplier	Carbon Black (C)	1333-86-4		1.59	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		122.43	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		19.08	mg
Plating	12.5	mg	Supplier	Tin (Sn)	7440-31-5		12.5	mg
Wire Bond - Au	0.033	mg	Supplier	Gold (Au)	7440-57-5		0.033	mg